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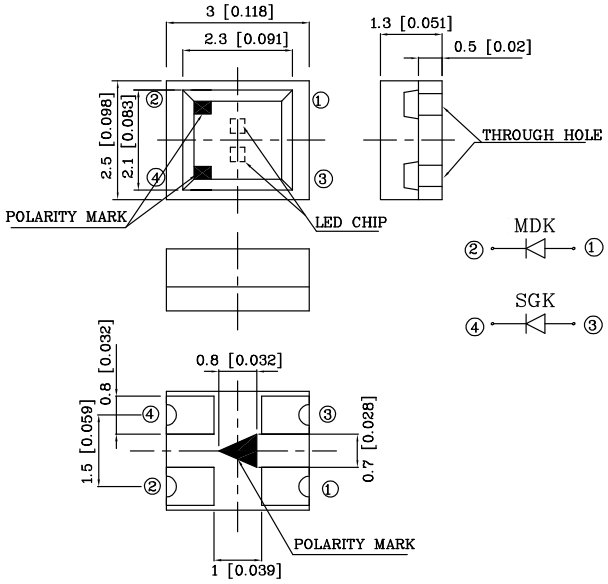
Part number: **XZMDKSGK70W**

3.0x2.5mm SURFACE MOUNT LED LAMP

Features

- 3.0mmx2.5mm SMT LED, 1.3mm THICKNESS.
- BI -COLOR,LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE : 2000PCS / REEL.
- RoHS COMPLIANT.



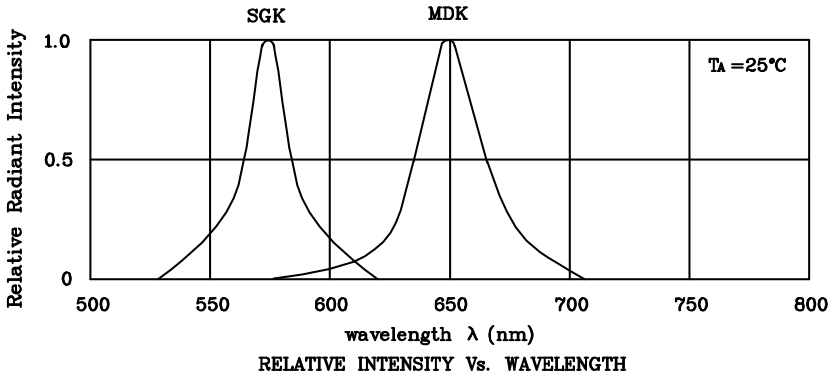
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.2(0.008") unless otherwise noted.

Absolute Maximum Ratings (TA=25°C)		**MDK (InGaAlP)**	**SGK (InGa AIP)**	**Unit**
Reverse Voltage	VR	5	5	V
Forward Current	IF	30	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	185	150	mA
Power Dissipation	PT	170	105	mW
Operating Temperature	TA	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~ +85		

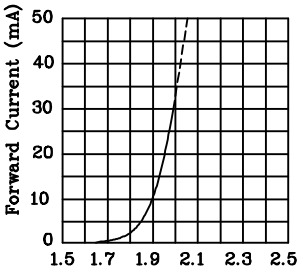
Operating Characteristics (TA=25°C)		**MDK (InGaAlP)**	**SGK (InGa AIP)**	**Unit**
Forward Voltage (Typ.) (IF=20mA)	VF	1.95	2.1	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	2.5	V
Reverse Current (VR=5V)	IR	10	10	uA
Wavelength of Peak Emission (IF=20mA)	λ P	650	574	nm
Wavelength of Dominant Emission (IF=20mA)	λ D	635	570	nm
Spectral Line Full Width At Half-Maximum (IF=20mA)	Δλ	28	20	nm
Capacitance (VF=0V, f=1MHz)	C	35	15	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd min.	Luminous Intensity (IF=20mA) mcd typ.	Wavelength nm λ P	Viewing Angle 2 θ 1/2
XZMDKSGK70W	Red	InGaAlP	Water Clear	70	148	650	120°
	Green	InGaAIP		10	49	574	

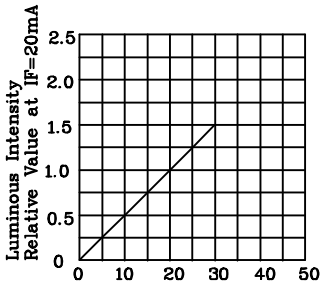


RELATIVE INTENSITY Vs. WAVELENGTH

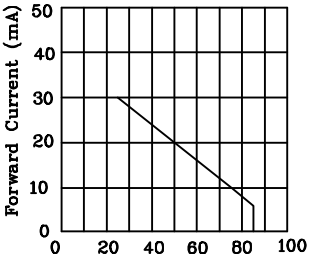
❖ **MDK**



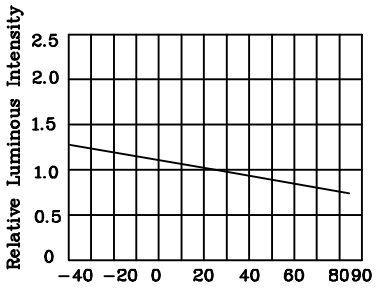
FORWARD CURRENT Vs.
FORWARD VOLTAGE



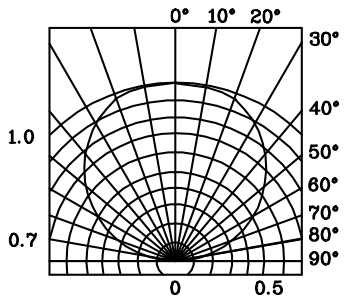
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

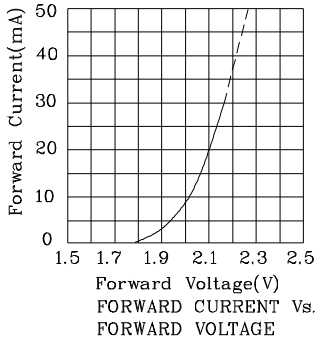


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

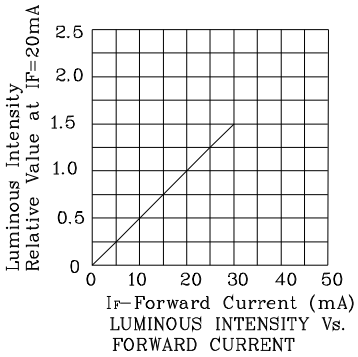


SPATIAL DISTRIBUTION

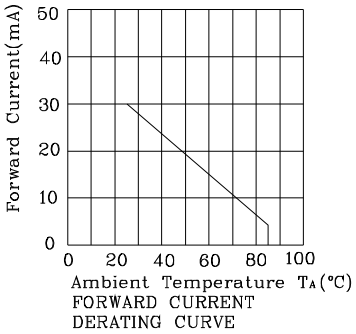
❖ **SGK**



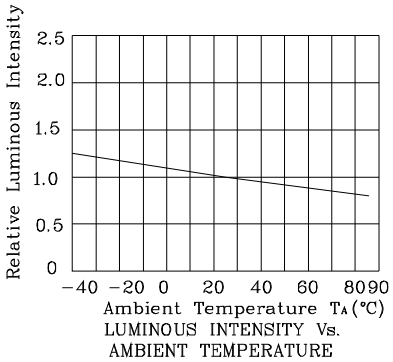
FORWARD CURRENT Vs.
FORWARD VOLTAGE



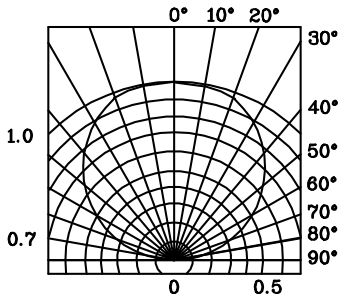
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

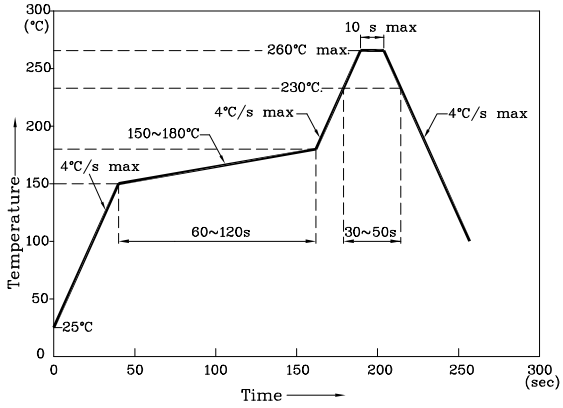


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

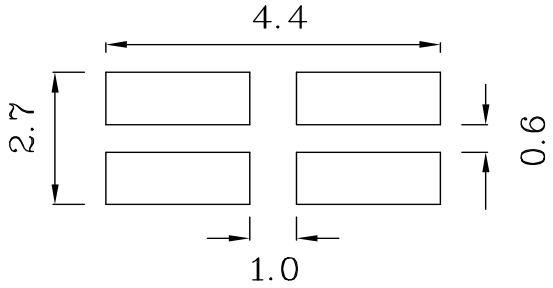
Reflow Soldering Profile For Lead-free SMT Process.



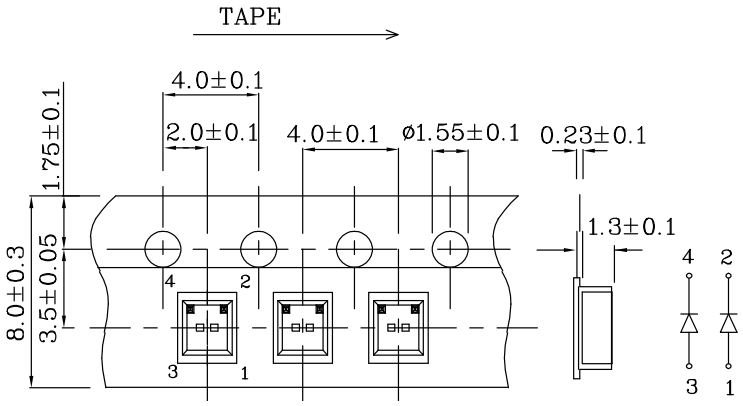
NOTES:

1. Maximum soldering temperature should not exceed 260°c.
2. Recommended reflow temperature: 145°c-260°c.
3. Do not put stress to the epoxy resin during high temperatures conditions.

❖ Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



❖ Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.